



PATENT

Atty. Dkt. No. AMAT/6218/DSM/LOW K/JW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Lang, et al.

Serial No.: 10/092,203

Confirmation No.: 8611

Filed: March 4, 2002

For: Method of Depositing a
Low Dielectric Barrier Film
for Copper Damascene
Application

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Group Art Unit: 1762

Examiner: Lynne A. Gurley

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING 37 CFR 1.8	
I hereby certify that this correspondence is being deposited on <u>7/14</u> , 2004 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
<u>7/14/04</u> Date	<u>[Signature]</u> Signature

Dear Sir:

RESPONSE TO OFFICE ACTION DATED MAY 20, 2004

In response to the Office Action dated May 20, 2004, having a shortened statutory period for response set to expire on August 20, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. The Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/ AMAT/6218/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

The Pending Claims are listed beginning on page 2 of this paper. **Remarks** begin on page 5 of this paper.